

Fig.1.



Fig.2.

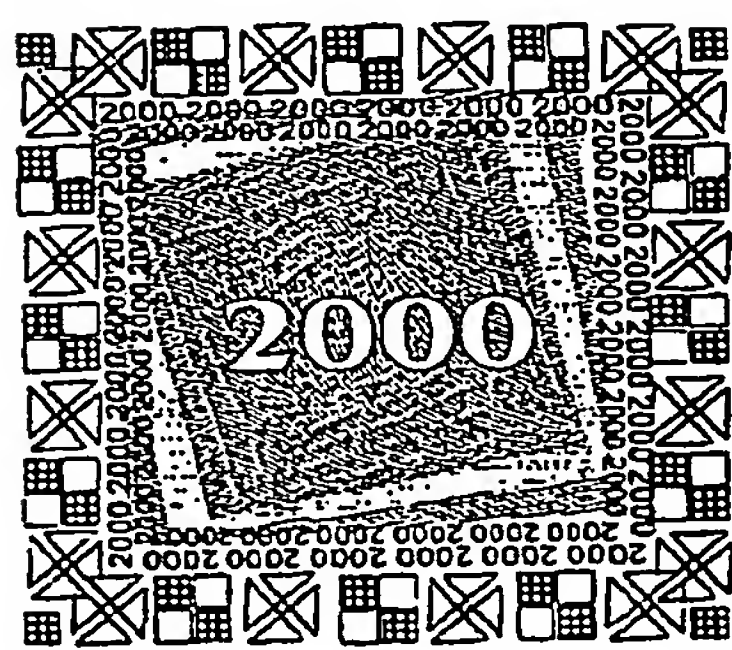
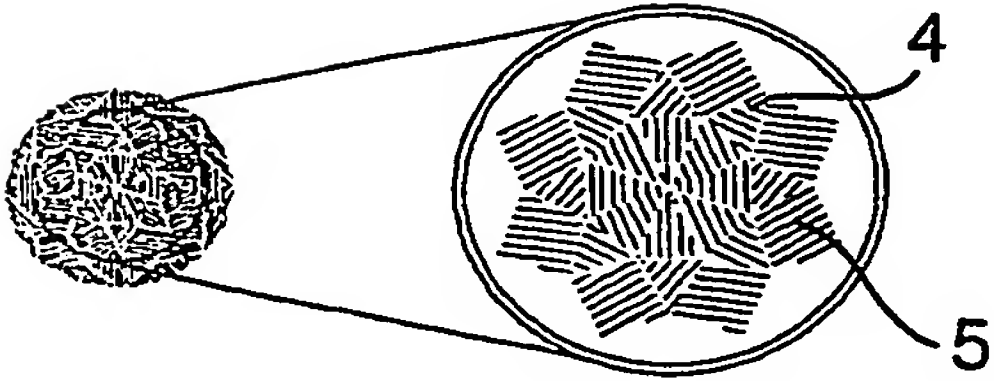


Fig.3.



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Fig.4A.

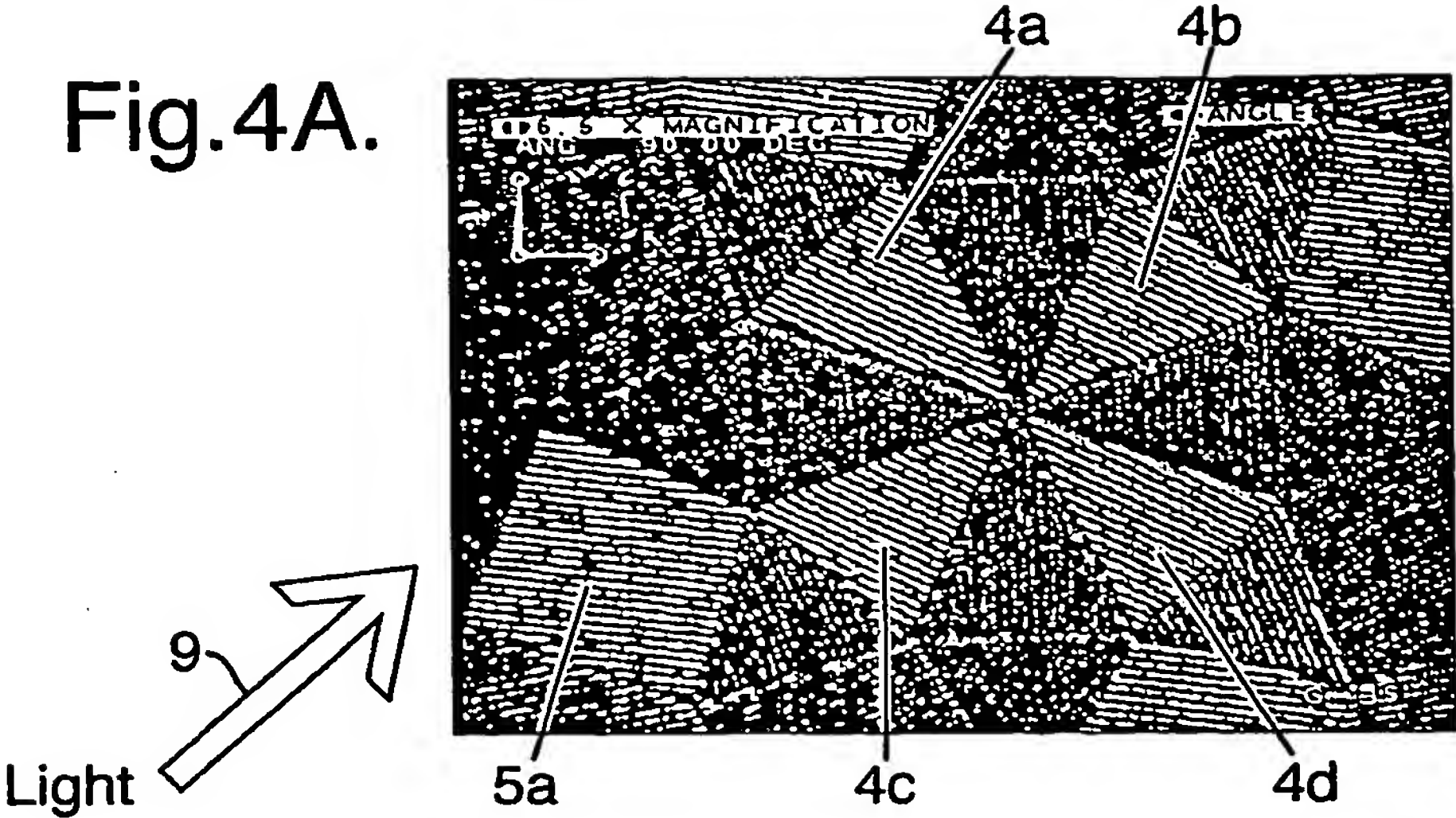


Fig.4B.

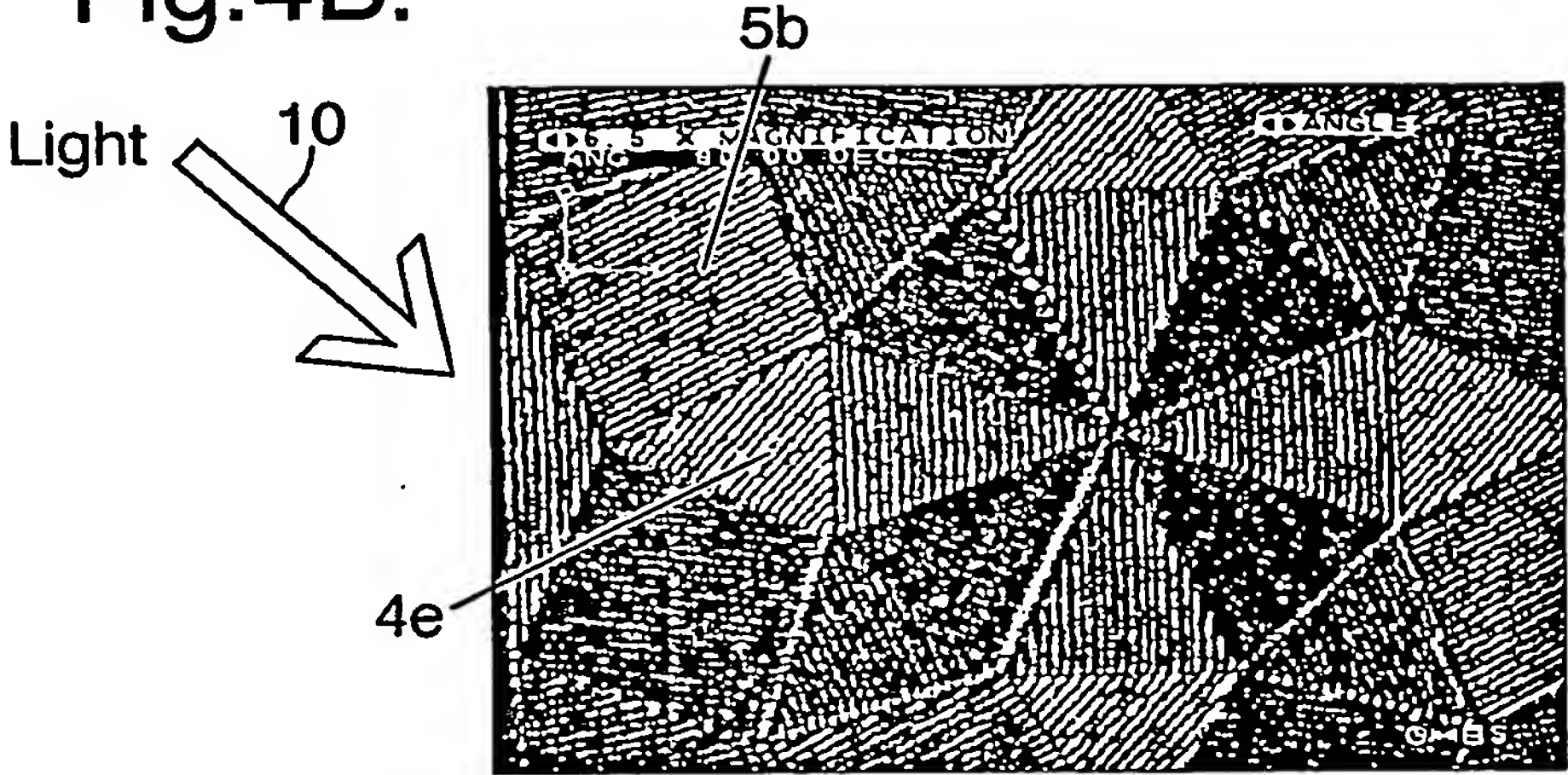


Fig.4C.

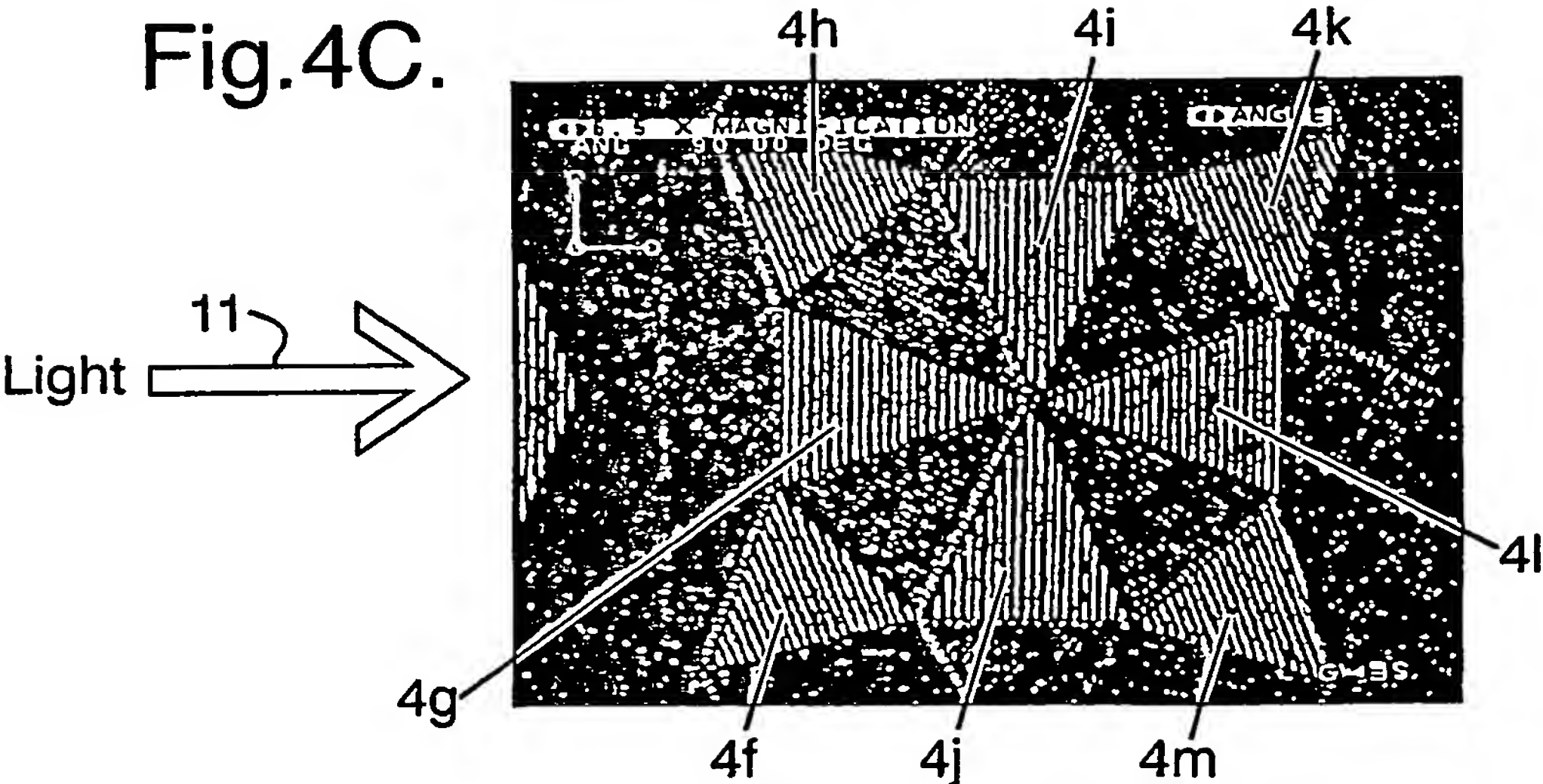


Fig.5A.

Plate filled with ink

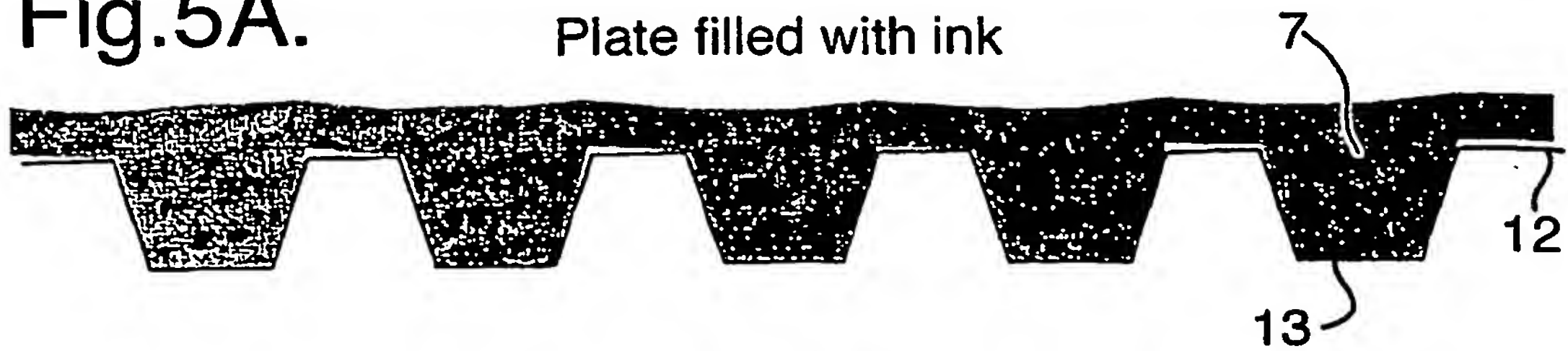


Fig.5B.

Inked plate following wiping

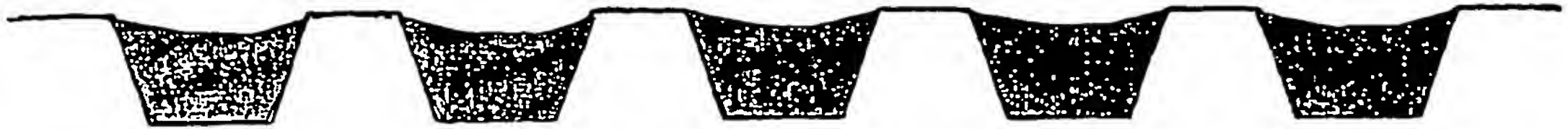


Fig.5C.

Substrate placed onto inked plate

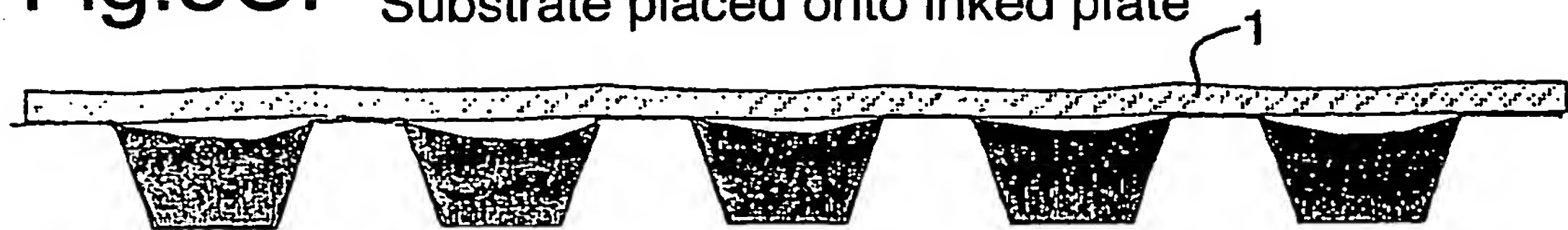


Fig.5D.

Pressure applied



Fig.5E.

Substrate removed - some ink remains in plate



Fig.5F.

Ink on substrate

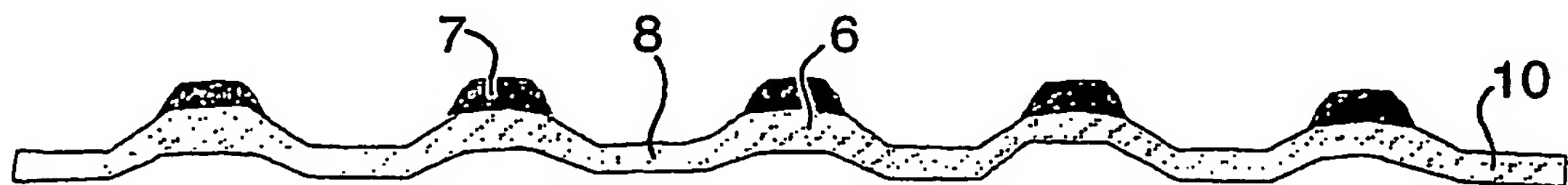




Fig.6A.

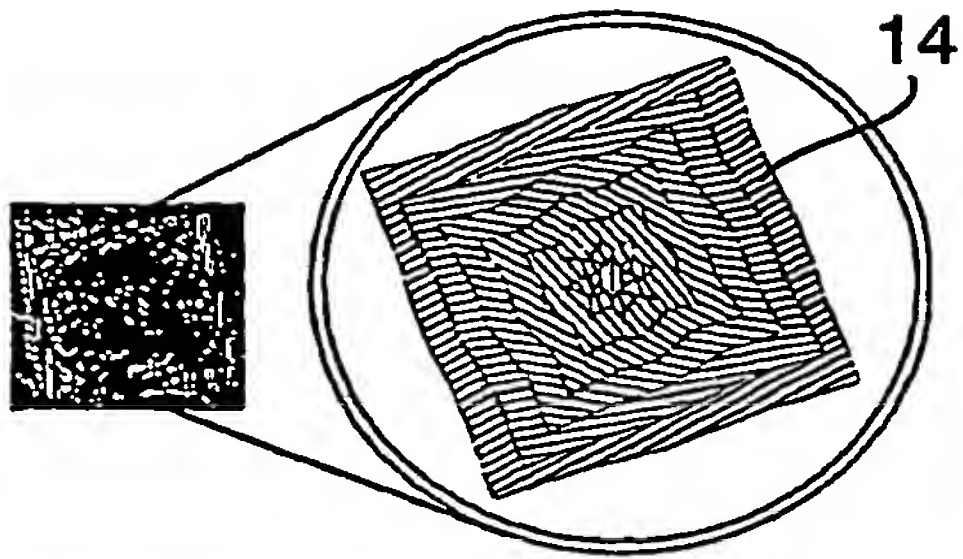


Fig.6B.

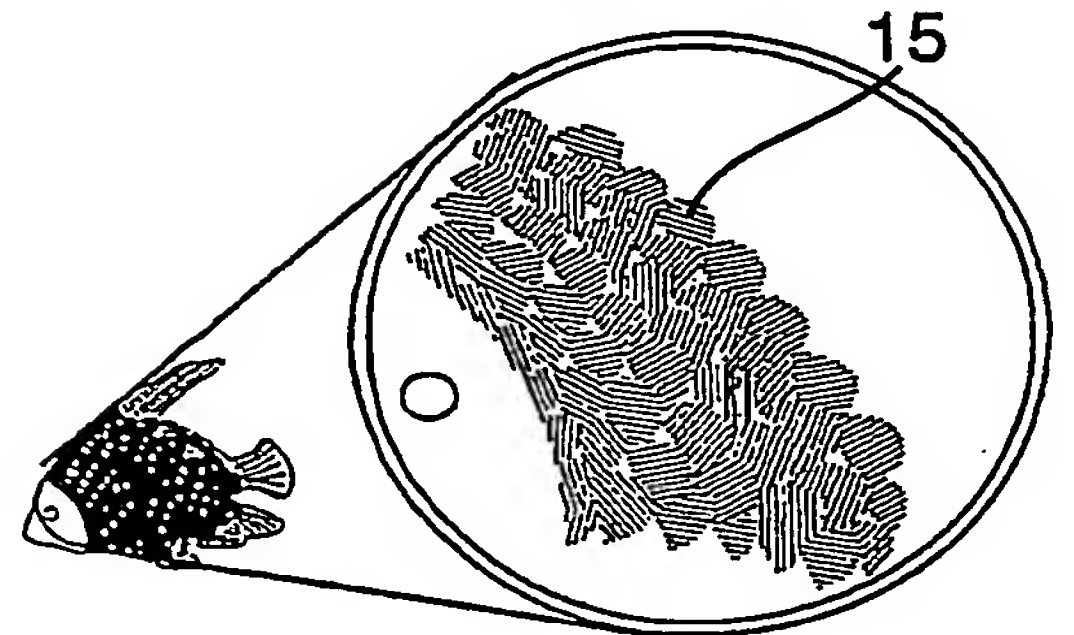


Fig.6C.

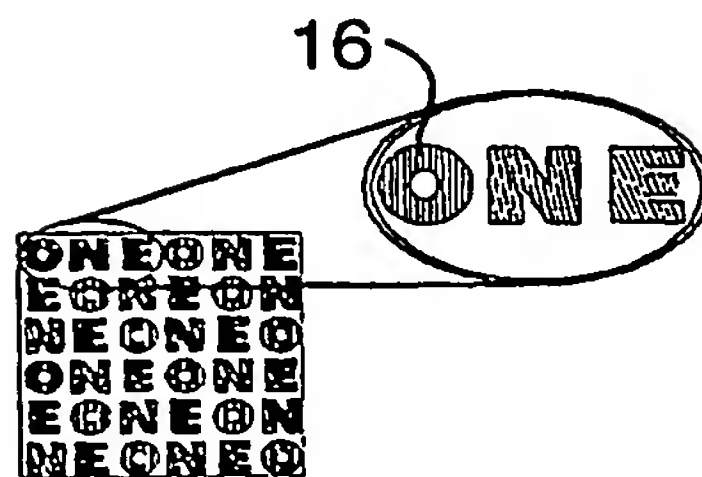


Fig.7A.

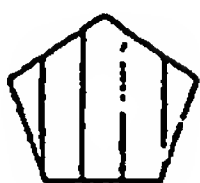


Fig.7B.



Fig.7C.

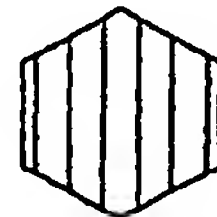


Fig.7D.



Fig.7E.



Fig.7F.

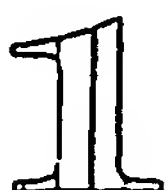
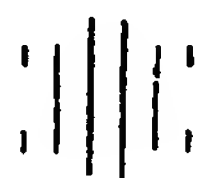


Fig.7G.



Fig.7H.



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Fig.8.

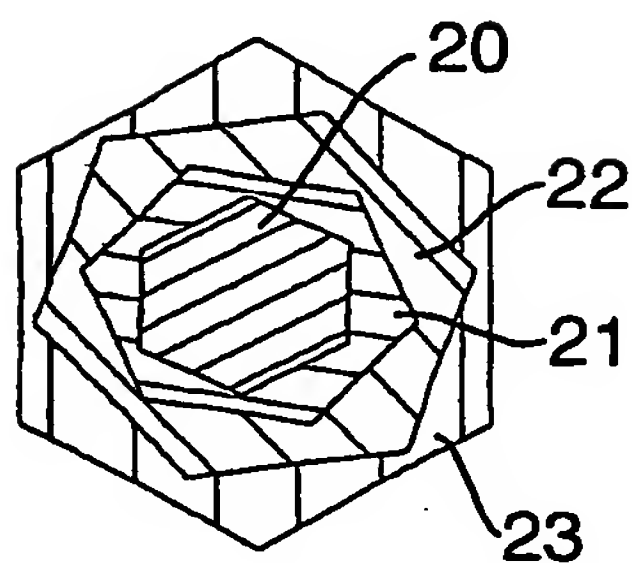


Fig.9A.

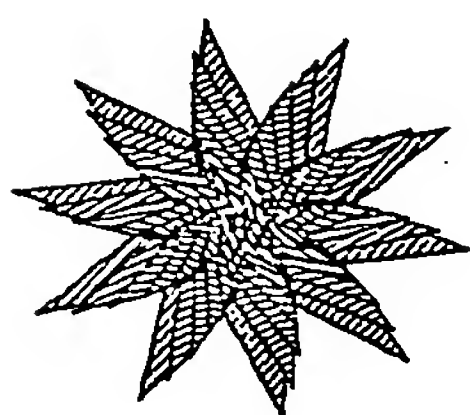


Fig.9B.

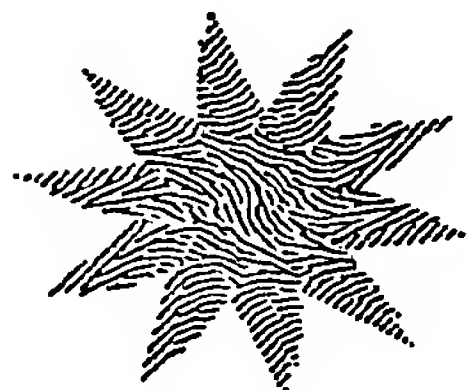


Fig.9C.

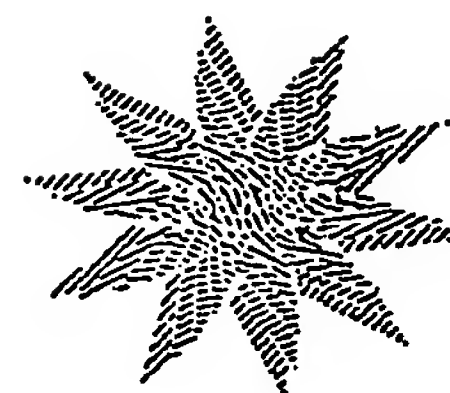


Fig.10.

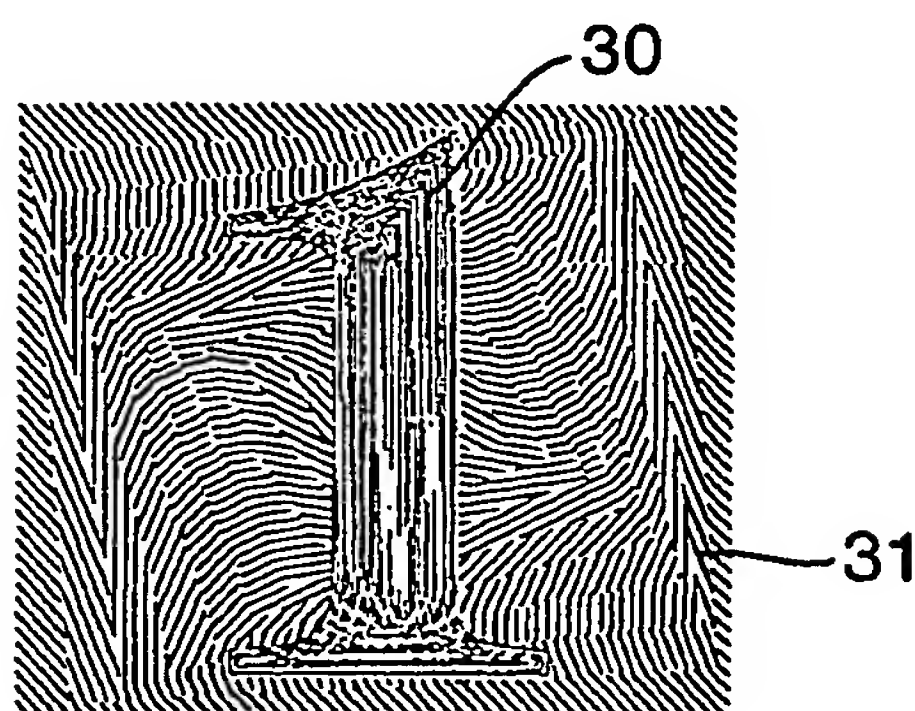


Fig.11A.

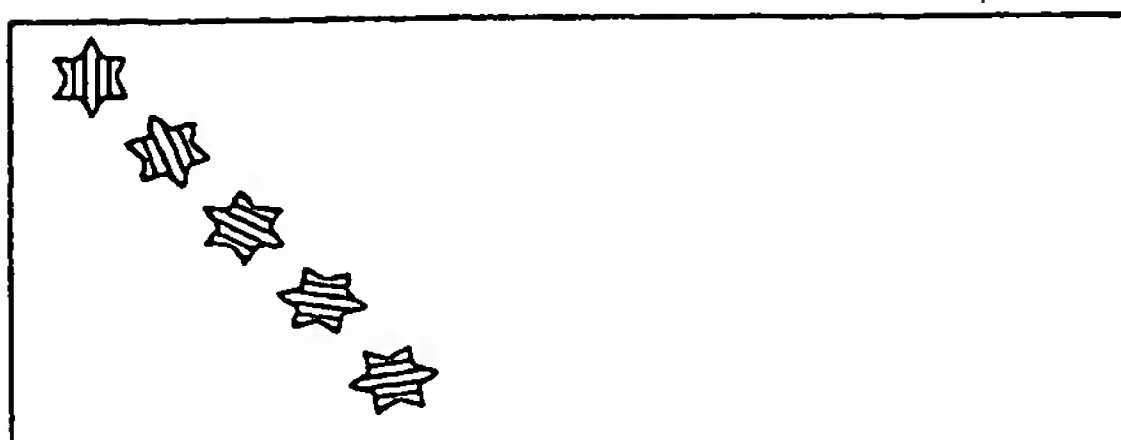


Fig.11B.

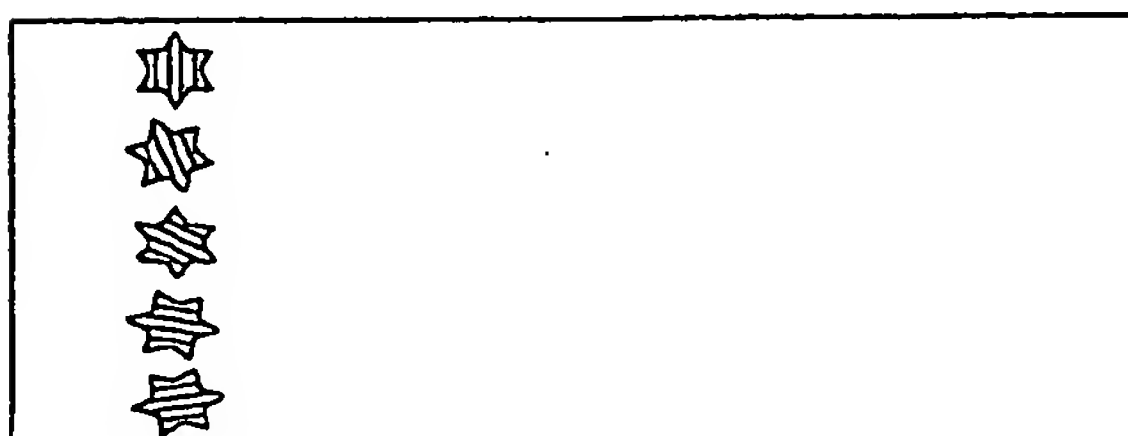


Fig.11C.

